Electronic Patent Application Fee Transmittal							
Application Number:	10	10622915					
Filing Date:	18-Jul-2003						
Title of Invention:	METHODS OF FORMING INTEGRATED CIRCUIT DEVICES INCLUDING A MULTI-LAYER POLY FILM CELL PAD CONTACT HOLE						
First Named Inventor/Applicant Name:	Yong-Chul Oh						
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Attorney Docket Number:	5649-1142						
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